

深圳立显科技有限公司

Model Name: LX T30WH006T1

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For Customer's Acceptance

Approved by	Comment

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1. General Specifications

1.1 Description

The LX T30WH006T1 VO is a color active matrix Thin Film Transistor (TFT) Liquid Crystal Display (LCD) that uses amorphous silicon (a-Si) TFT as a switching device. This model is composed of a single 3.0 inches transmissive type main TFT-LCD panel. The resolution of the panel is 240*400 pixels and can display up to 262K color.

1.2 Features

- TN type for main TFT-LCD panel
- 80-system parallel bus
- Full, Still, Partial & Sleep modes are available

1.3 Application

- Display terminals for cellular phone

1.4 General Specification

No.	Item	Specification	Unit	Remark
1	LCD Size	3.0	inch	-
2	Panel Type	TFT	-	-
3	Resolution	240 x RGB x 400	pixel	-
4	Display Mode	Transmissive	-	-
5	Display Number of Colors	262K	-	-
6	Viewing Direction	12 o'clock	-	-
7	Module Size	45.04(W) x 77.0(L) x 2.4(D)	mm	-
8	LCD Active Area	38.88(W) x 64.80(L)	mm	-
9	Pixel Pitch	0.162mmx0.162mm	mm	-
10	Driver IC	OTM4001A	-	-
11	Light Source	4 White LEDs in Parallel	-	-
12	Interface	8080 8/9/16/18 bit parallel	-	-
13	Operating Temperature	-20~+70		-
14	Storage Temperature	-30~+80		-

Note 1: Please refer to the mechanical drawing.

2. Pin Assignments

Pin No.	Symbol	I/O	Function	Remark
1	YU	I	Pin for TP	-
2	XL	I	Pin for TP	-
3	YD	I	Pin for TP	-
4	XR	I	Pin for TP	-
5	GND	P	Ground	-
6	DVCC	P	Supply Voltage for I/O	-
7	VCC	P	Supply Voltage	-
8	FMARK	O	Frame head pulse signal	-
9	CS	I	Chip Select Signal	-
10	RS	I	Register Select Signal	-
11	WR	I	Write Data Signal	-
12	RD	I	Read Data Signal	-
13	D0	I/O	Data bus	-
14	D1	I/O	Data bus	-
15	D2	I/O	Data bus	-
16	D3	I/O	Data bus	-
17	D4	I/O	Data bus	-
18	D5	I/O	Data bus	-
19	D6	I/O	Data bus	-
20	D7	I/O	Data bus	-
21	D8	I/O	Data bus	-
22	D9	I/O	Data bus	-
23	D10	I/O	Data bus	-
24	D11	I/O	Data bus	-
25	D12	I/O	Data bus	-
26	D13	I/O	Data bus	-
27	D14	I/O	Data bus	-
28	D15	I/O	Data bus	-
29	D16	I/O	Data bus	-
30	D17	I/O	Data bus	-
31	M1	I	Select a mode to interface to an MPU	
32	M0	I	Select a mode to interface to an MPU	
33	NC	/	Leave It Open	
34	RESET	I	Reset Signal	
35	GND	P	Ground	
36	LEDA	P	LED A	
37	LEDK1	P	LED K	

38	LEDK2	P	LED K	
39	LEDK3	P	LED K	
40	LEDK4	P	LED K	

3. Electrical Specifications

3.1 Absolute Maximum Rating

(T_a=+25)

Item		Symbol	Values		Unit	Remark
			Typ.	Max.		
TFT Module	I/O circuit Supply Voltage	DVCC	-0.3	+4.5	V	Note1
	Analog Supply Voltage	VCI	-0.3	+4.5	V	Note1
Backlight Unit	Current	I _b	-	200	mA	Note2
	Power Consumption	P _{BL}	-	700	mW	Note2

Note1: Permanent damage to the device may occur if maximum values are exceeded or reverse voltage is applied.

Note2: Without LED driver IC, please refer to 4.3.

3.2 Typical Operation Conditions

3.2.1 DC Characteristics

(T_a=+25)

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
I/O circuit Supply Voltage	DVCC	-	3.0	3.3	V	Backlight Lumiance= 3500cd/m ² (V _B =3.1V)
Analog Supply Voltage	VCI	2.8	3.0	3.3	V	
Input High Voltage	V _H	0.8 DVCC	-	DVCC	V	
Input Low Voltage	V _L	-0.3	-	0.2 DVCC	V	
Output High Voltage	V _{OH}	0.8 DVCC	-	DVCC	V	
Output Low Voltage	V _{OL}	0	-	0.2 DVCC	V	
Frame Frequency	f _{FRAME}	-	80	-	Hz	
Backlight Current(V=3.1V)	I _b	-	60	80	mA	

Note: To prevent latch up or DC operation in LCD panel, the power on/off sequence should follow the driver IC specification.

3.2.2 Current Consumption

(T_a=+25)

Item	Symbol	Values		Unit	Remark
		Typ.	Max.		
Still Mode	DVCC	20	30	uA	Note1
	VCI	10	14	mA	Note1
Sleep Mode	DVCC	10	15	uA	Note1, Note2
	VCI	100	150	uA	Note1, Note2

Note1: Test Condition

Typ: DVCC=2.8V

VCI=2.8V

Display Pattern: 8 Color Bar

Frame Rate=80Hz at Line Inversion

Max: DVDD=3.3V

VCI=3.3V

Display Pattern: All Pixel Black

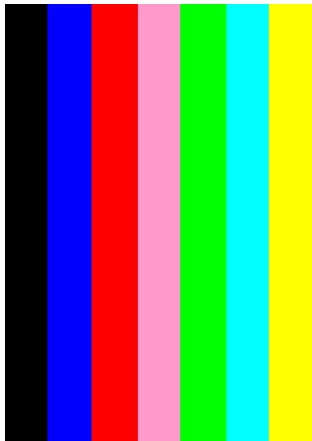
Frame Rate=80Hz at Line Inversion

Operating Temperature: 25

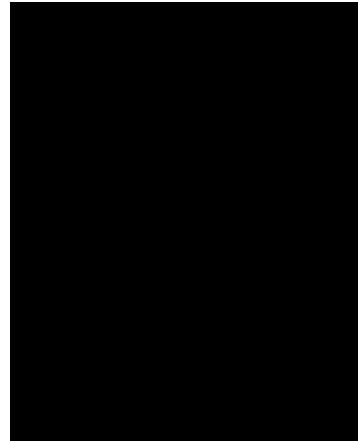
Typ. current check pattern:

Operating Temperature: 25

Max. Current check pattern:



8-Color bar

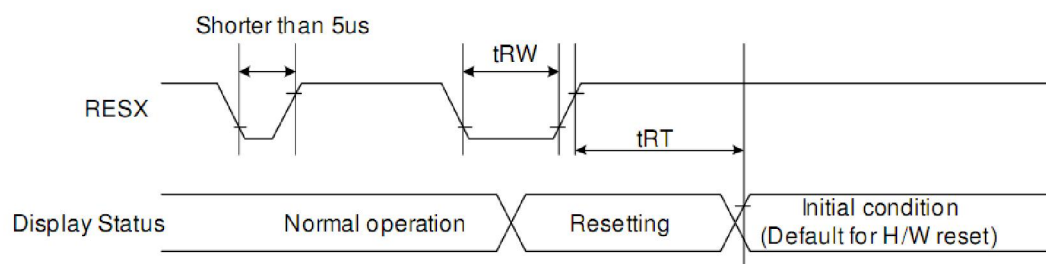


Black

Note2: In the sleep mode, all the internal display operations are suspended except for the internal R-C oscillator.

3.3 Timing Characteristic

3.3.1 Reset Timing



Signal	Symbol	Parameter	Min	Max	Unit
RESX	tRW	Reset pulse duration	10		uS
	tRT	Reset cancel		5 (note 1,5)	mS
				120 (note 1,6,7)	mS

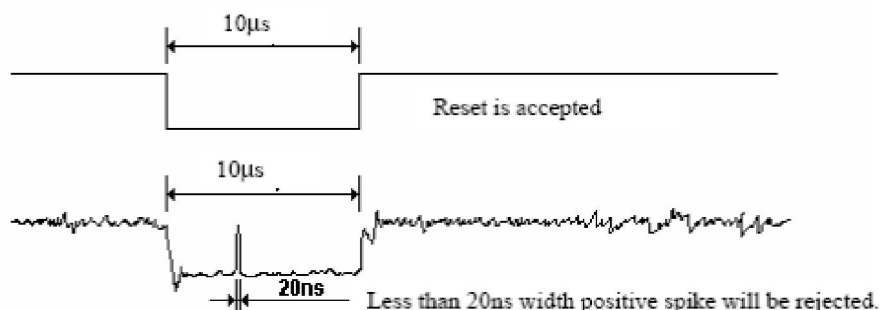
Note 1: The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NV memory to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.

Note 2: Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below: -

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 10us	Reset
Between 5us and 10us	Reset starts

Note 3: During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In -mode.) And then return to Default condition for Hardware Reset.

Note 4: Spike Rejection also applies during a valid reset pulse as shown below:

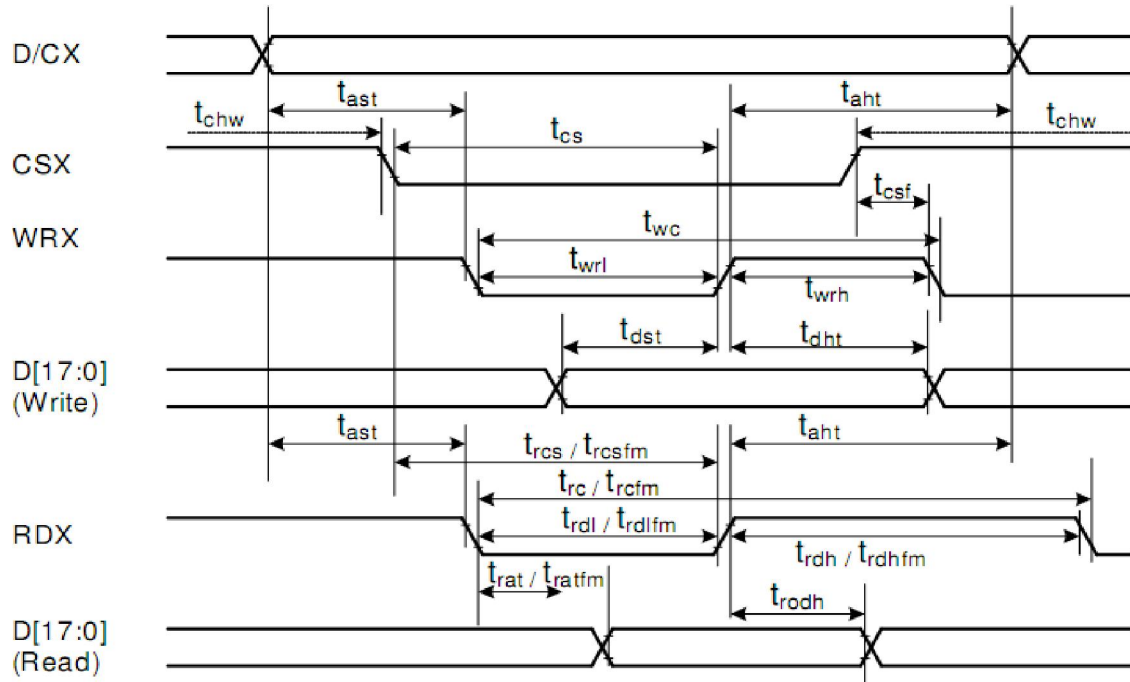


Note 5: When Reset applied during Sleep In Mode.

Note 6: When Reset applied during Sleep Out Mode.

Note 7: It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

3.3.2 Parallel Interface Characteristics (8080-series MPU)



($V_C = 2.8$ to $3.3V$, $DVCC = 2.8$ to $3.3V$, $T_a = 25$)

Signal	Symbol	Parameter	min	max	Unit	Description
DCX	tast	Address setup time	0	-	ns	
	taht	Address hold time (Write/Read)	0	-	ns	
CSX	tchw	CSX "H" pulse width	0	-	ns	
	tcs	Chip Select setup time (Write)	15	-	ns	
	trcs	Chip Select setup time (Read ID)	45	-	ns	
	trcsfm	Chip Select setup time (Read FM)	355	-	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	-	ns	
WRX	twc	Write cycle	66	-	ns	
	twrh	Write Control pulse H duration	15	-	ns	
	twrl	Write Control pulse L duration	15	-	ns	
RDX (FM)	trcfm	Read Cycle (FM)	450	-	ns	
	trdhfm	Read Control H duration (FM)	90	-	ns	
	trdlfm	Read Control L duration (FM)	355	-	ns	
RDX (ID)	trc	Read cycle (ID)	160	-	ns	
	trdh	Read Control pulse H duration	90	-	ns	
	trdl	Read Control pulse L duration	45	-	ns	
D[17:0], D[17:10]&D[8:1], D[17:10], D[17:9]	tdst	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	tdht	Write data hold time	10	-	ns	
	trat	Read access time	-	40	ns	
	tratfm	Read access time	-	340	ns	
	trod	Read output disable time	20	80	ns	

Note: $T_a = -30$ to 70 °C, $VDDI = 1.65V$ to $3.3V$, $VCI = 2.5V$ to $3.3V$, $VSS = 0V$.

4. Optical Specifications

(Ta=+25℃, VCL=+3.2V, DVCC=+3.2V, VB=3.1)

Item		Sym bol	Cond ition	Val ues			Un it	Rem ark
				M in.	Typ .	Max.		
View ing Angle Range	Left	L	CR> 10	65	75	-	deg ree	No te 1,2
	Right	R		65	75	-		
	Top	T		65	75	-		
	Bottom	B		45	55	-		
Response Time		T _{on} +T _{off}	Normal = =0°	-	-	30	m s	No te 2,3
ContrastRatio		CR	Normal = =0° angle	350	450	-	-	No te 2,4
Lum inance		L	Normal = =0°	-	150	-	cd /m ²	No te 2,5
Cobr Chrom a ticity (C E1931)	White	W _x	Normal = =0°	-	0.263 9	-	-	No te 2,6
		W _y		-	0.333 2	-		
	Red	R _x		-	0.523 5	-		
		R _y		-	0.312 3	-		
	Green	G _x		-	0.294 4	-		
		G _y		-	0.525 2	-		
	Blue	B _x		-	0.158 7	-		
		B _y		-	0.089 7	-		
CobrGamut		NTSC	C E1931	-	45	-	%	-
Lum inance Unifo m ity		U _L	Normal = =0°	75	80	-	%	No te 2,7
Flicker		-	-	No Visib le			-	No te 8
Crosstalk		-	-	No Visib le			-	No te 9

Note 1: Definition of viewing angle range

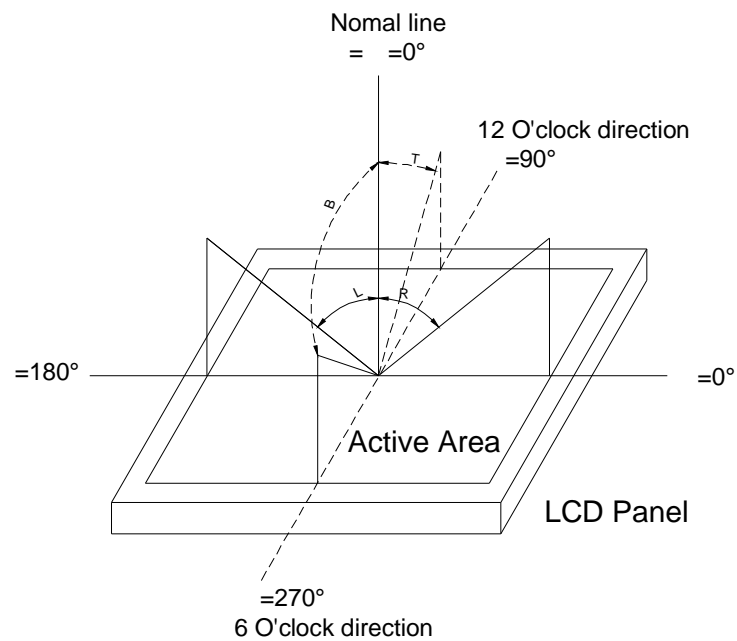


Fig . 1 Definition of view ing angle

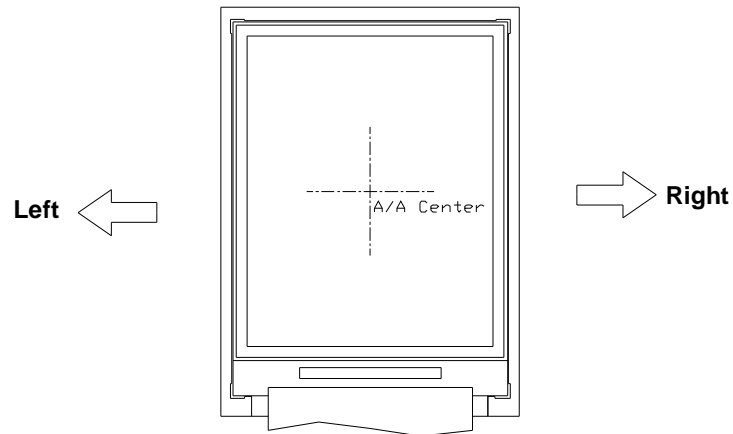


Fig . 2 Definition of view ing angle for display

Note 2: Definition of optical measurement system

The optical characteristics should be measured in a dark room with ambient temperature $T_a = +25$. The optical properties are measured at the center point of the LCD screen after 5 minutes operation. (Equipment: Photo detector TOPCON BM -5A or BM -7 /Field of view : 1° /Height: 500mm .)

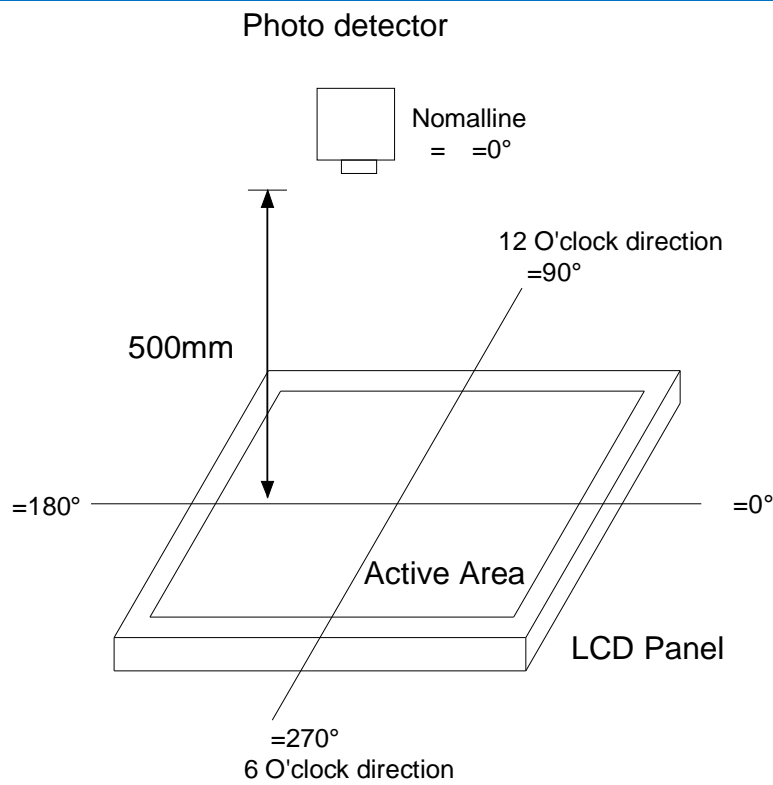


Fig. 3 Optical measurement system setup

Note 3: Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{on}) is the time between photo detector output intensity changed from 90% to 10%, and fall time (T_{off}) is the time between photo detector output intensity changed from 10% to 90%.

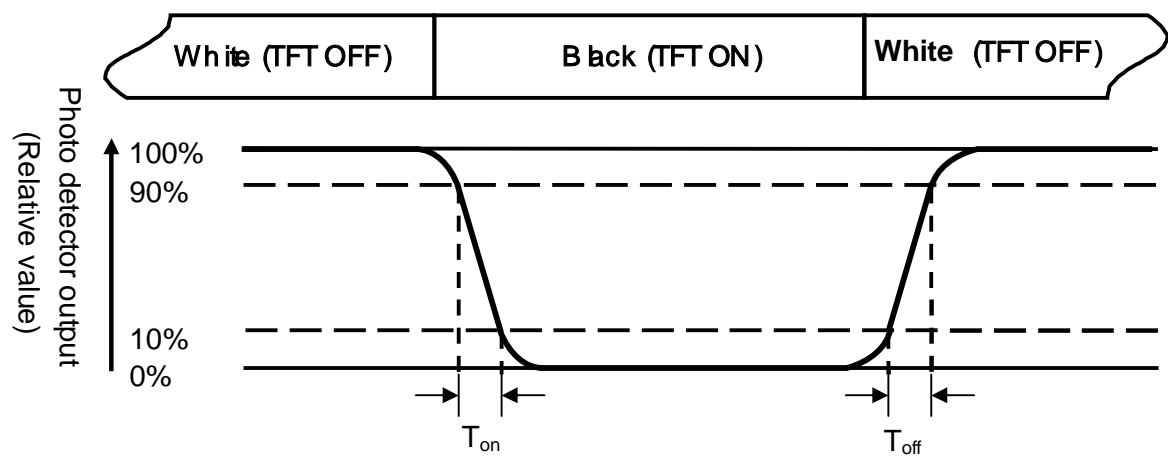


Fig. 4 Definition of response time

Note 4: Definition of contrast ratio

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: Definition of luminance

Measured at the center area of the panel when LCD panel is driven at "white" state.

Note 6: Definition of color chromaticity (CIE1931)

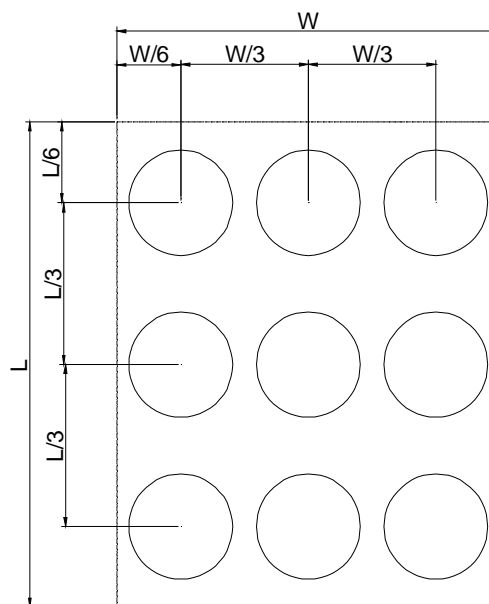
Color coordinates measured at the center point of LCD when panel is driven at "White", "Red", "Green" and "Blue" state respectively.

Note 7: Definition of luminance uniformity

To test for uniformity, the tested area is divided into 3 rows and 3 columns. The measurement spot is placed at the center of each circle as below.

$$\text{Luminance Uniformity (U}_L\text{)} = \frac{L_{\min}}{L_{\max}}$$

L-----Active area length W----- Active area width



L_{\max} : The measured maximum luminance of all measurement positions.

L_{\min} : The measured minimum luminance of all measurement positions.

5. Reliability Test Items

Test Items	Test Conditions	Remark
High Temperature Storage	+80 ± 2 for 96 hours	-
Low Temperature Storage	-30 ± 3 for 96 hours	-
High Temperature Operation	+70 ± 2 for 96 hours	-
Low Temperature Operation	-20 ± 2 for 96 hours	-
High Temperature and Humidity Operation	+40 ± 2 , 95% ± 2% RH max. for 96 hours	-
Thermal Shock	-30 /0.5h ~ +80 /0.5h for a total 100 cycles, Start with cold temp and end with high temp	-
Vibration Test	Frequency range:10~55Hz Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X. Y. Z. (6 hours for total)	-
Mechanical Shock	100G 6ms, ± X, ± Y, ± Z 3 times for each direction	-
Package Vibration Test	Random Vibration : 0.015G ² /Hz from 5-200Hz, -6dB/Octave from 200-500Hz 1 hour for each direction of X. Y. Z. (3 hours for total)	-
Package Drop Test	Height :72cm (Weight 10kg); 60cm (Weight >10kg) 1 corner, 3 edges, 6 surfaces	-
Electro Static Discharge	± 2KV, Human Body Mode, 100pF/1500	-

Note1: During the display practical test under normal operation condition, there shall be no change or effect to the display function.

Note2: Before function check, the test sample requires 2 hours storage at room temperature. Before test the function of TP, the sample must be placed in room temperature for 24hrs after RA test.

6. Handling Precautions

6.1 Safety

6.1.1 The liquid crystal in the LCD is poisonous. DO NOT put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

6.2 Handling

6.2.1 The LCD and touch panel is made of plate glass. DO NOT subject the panel to mechanical shock or to excessive force on its surface.

6.2.2 Do not handle the product by holding the flexible pattern portion in order to assure the reliability

6.2.3 Transparency is an important factor for the panel. Please wear clear finger sacks, gloves and mask to protect the touch panel from fingerprint or stain and also hold the portion outside the view area when handling the touch panel.

6.2.4 Provide a space so that the panel does not come into contact with other components.

6.2.5 To protect the product from external force, put a covering lens (acrylic board or similar board) and keep an appropriate gap between them.

6.2.6 Transparent electrodes may be disconnected if the panel is used under environmental conditions where dew condensation occurs.

6.2.7 Property of semiconductor devices may be affected when they are exposed to light, possibly resulting in IC malfunctions.

6.2.8 To prevent such IC malfunctions, your design and mounting layout shall be done in the way that the IC is not exposed to light in actual use.

6.3 Static Electricity

6.3.1 Ground soldering iron tips, tools and testers when they are in operation.

6.3.2 Ground your body when handling the products.

6.3.3 Power on the LCD module BEFORE applying the voltage to the input terminals.

6.3.4 DO NOT apply voltage which exceeds the absolute maximum rating.

6.3.5 Store the products in an anti-electrostatic bag or container.

6.4 Storage

6.4.1 Store the products in a dark place at $+25 \pm 10$ with low humidity (65%RH or less).

6.4.2 DO NOT store the products in an atmosphere containing organic solvents or corrosive gas.

6.5 Cleaning

6.5.1 DO NOT wipe the panel with dry cloth, as it may cause scratch.

6.5.2 Wipe off the stain on the product by using soft cloth moistened with ethanol.

DO not allow ethanol to get in between the upper film and the bottom glass. It may cause peeling issue or defective operation. Do not use any organic solvent or detergent other than ethanol.

8. Touch Panel

T.B.D

9. Cosmetic Specification

9.1 Incoming Inspection

Both parties agree that the inspection specifications of TFT-LCD Modules (hereinafter known as "Modules") stipulated hereunder is the only and final standard applicable in the process of inspection. Gold-Vision shall be under no liability or obligation (including incidental loss, products liability or other consequential loss) whatsoever for any defect in quality or performance or shortage in quantity of the Modules that have passed such inspection.

9.2 Liability

9.2.1 Inspection Deadline

The Customer should inspect the Modules either at the Delivery Point or within twenty (20) calendar days after arrival at the Delivery Destination.

9.2.2 Notification of Rejection

The Customer may reject one or more defective or non-conforming Modules if the Modules fail to meet the AQL (Acceptable Quality Level) and pass the inspection. In that case, the customer should notify Gold-Vision of the rejection by either documents or mail within five (5) business days from the date of reception of the Modules. Otherwise, the Modules shall be deemed to have met the AQL and passed the inspection.

9.3 Inspection Specifications

Both parties agree that the inspection shall contain and follow the inspection specifications stipulated in the Inspection Specifications (see attachment), including:

- Scope
- Sampling Plan
- Panel Inspection Condition
- Display Quality
- Mechanics Specifications
- Notification for Storage Handling

9.4 Limited Warranty

Gold-Vision represents and warrants that all Modules shall (i) conform to the specifications set hereunder, and (ii) be free from any defects in material and workmanship for twelve (12) months after the Customer's acceptance or deemed acceptance. Gold-Vision will replace, rework or refund the Customer for the defective or non-conforming Modules at Gold-Vision's option, provided that the Customer (i) promptly informs Gold-Vision of the defects or non-conformities within the warranty period, (ii) complies with the specifications and conditions hereunder, and (iii) complies with Gold-Vision's procedure for Modules replacement, reworking and/or return. The warranty period for the Modules replaced or reworked shall be the remaining term for such Modules.

9.5 Warranties

The warranties and remedies set forth above are exclusive and in lieu of all other or by operation of law, statutory or otherwise, including warranties or confer warranties, terms or conditions, express or implied, either in fact or of merchantability and fitness for a particular purpose, all of which are expressly disclaimed.

Gold-vision warranties herein apply only to the customer and are not to be extended to any third party.

9.6 Governing Law

This Agreement shall be governed and construed in accordance with the laws of the Republic of China. Both parties agree to submit any dispute, which cannot be amicably resolved, to Court for the first instance.

9.7 Inspection Specifications Expand

9.7.1 SCOPE

Specifications contain
Display Quality Evaluation
Mechanics Specification

9.7.2 SAMPLING PLAN

Unless there is other agreement, sampling plan for incoming inspection should follow MIL-STD-105E.

9.7.2.1 Lot size: Quantity per shipment as one lot (different model as different lot.)

9.7.2.2 Sampling type: Normal inspection, single sampling.

9.7.2.3 Sampling level: Level II.

9.7.2.4 AQL: Acceptable Quality Level

Major defect: AQL=0.65%

Minor defect: AQL=1.0%.

9.7.3 PANEL INSPECTION CONDITION

9.7.3.1 Environment:

Room Temperature: 23 ± 3 .

Humidity: $55 \pm 5\%$ RH.

Illumination: 800~1200Lux.

9.7.3.2 Inspection Distance

35 ± 5 cm from the inspector to the module.

9.7.3.3 Inspection Angle:

9.7.4 Display Quality

9.7.4.1 Function Related:





The function defects such as line defect, abnormal display, no display are considered as the major defects. (N: The number of defects in non-performing; d: Defects from each other; D: Bad spot diameter; L: Bad line length; W: Line width of non-performing)

9.7.4.2 Bright/Dark Dots

Defect Type	Specification	Major	Minor
Bright Dots	$N = 0$		
Dark Dots	$N \leq 2$		
Total Bright and Dark Dots	$N \leq 2$		
Distance between defect dots	$d \geq 10$ mm		
Distance between dark dots	$d \geq 10$ mm		

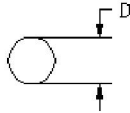
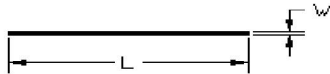
Note: Dot defect is defined as the defective area of the dot area is larger than 50% of the dot area.

9.7.4.3 Pixel Definition

R	G	B	R	G	B	R	G	B				Dot Defective
R	G	B	R	G	B	R	G	B				Defective Pixel
R	G	B	R	G	B	R	G	B				Defective Adjacent Sub-Pixels
												Defective Adjacent Pixels

Note: In cases where partial sub-pixel or pixel defects exceed 50% of the affected sub-pixel or pixel area, it will be counted as 1 defect.

9.7.4.4 Visual Inspection specification

Defect Type		Specification Size	Count (N)	Major	Minor
Dot Shape (Particle Scratch and Bubbles in display area) 		D <= 0.1 mm	Ignored		
		0.1mm < D <= 0.2mm	N <= 2 d>=10mm		
		D > 0.2mm	N=0		
Line Shape (Particles Scratch Lint and Bubbles in display area) 		W <= 0.03 mm	Ignored		
		0.03< W <= 0.05mm & L <=5mm	N <= 2 d>=10mm		
		W > 0.05mm or L >5mm	N=0		
Bubble in cell (active area)		It should not be found by eyes.			
Dent/Bump on Polarizer		The defects confirmed only in a glare state in which the light is reflected on the polarizer are neglect.			
Bezel	Scratch	No ham			
	Dirt				
	Wrap	No ham			
	Sunken	No ham			
Label	No label	NG			
	Invert label				
	Broken				
	Dirt	Word can be read.			
	Not clear				
	Mistake	NG			
	Position	Be attached on right position			
Connector	Connection status	No bend on pins and damage			
FPC	Broken	NG			

Note: Extraneous substance and scratch do not affect the display of image, for instance, the extraneous substance under polarizer film but outside the display area, scratch on metal bezel and backlight module or polar.

10. Record of Revision

Version	Revise Date	Page	Content
1.0	2013-11-18	20	Initial Release